

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5762856

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the EXECUTION DATES OF 2ND AND 3RD INVENTORS previously recorded on Reel 050014 Frame 0930. Assignor(s) hereby confirms the 2ND INVENTOR CHIKARA KONDO EXECUTION DATE: 06/15/2016; 3RD INVENTOR HIROYUKI TANAKA EXECUTION DATE: 06/15/2016.
CONVEYING PARTY DATA	
Name	Execution Date
TOMOYUKI SHIBATA	06/15/2016
CHIKARA KONDO	06/15/2016
HIROYUKI TANAKA	06/15/2016
RECEIVING PARTY DATA	
Name:	MICRON TECHNOLOGY, INC.
Street Address:	8000 SOUTH FEDERAL WAY
City:	BOISE
State/Country:	IDAHO
Postal Code:	83716-9632
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16537076
CORRESPONDENCE DATA	
Fax Number:	(206)903-8820
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2069038800
Email:	wang.jean@dorsey.com
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Address Line 2:	701 FIFTH AVENUE, SUITE 6100
Address Line 4:	SEATTLE, WASHINGTON 98104-7043
ATTORNEY DOCKET NUMBER:	P258541.US.02
NAME OF SUBMITTER:	JEAN WANG
SIGNATURE:	/Jean Wang/
DATE SIGNED:	10/09/2019
Total Attachments: 5	

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PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1

Stylesheet Version v1.2

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>TOMOYUKI SHIBATA</td><td>06/15/2016</td></tr><tr><td>CHIKARA KONDO</td><td>06/15/2019</td></tr><tr><td>HIROYUKI TANAKA</td><td>06/15/2019</td></tr></tbody></table>		Name	Execution Date	TOMOYUKI SHIBATA	06/15/2016	CHIKARA KONDO	06/15/2019	HIROYUKI TANAKA	06/15/2019		
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CORRESPONDENCE DATA											
Fax Number:	(206)903-8820										
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ATTORNEY DOCKET NUMBER:	P258541.US.02
NAME OF SUBMITTER:	JEAN WANG
Signature:	/Jean Wang/
Date:	08/09/2019
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RECEIPT INFORMATION EPAS ID: PAT5662137 Receipt Date: 08/09/2019	

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Tomoyuki Shibata, Chikara Kondo, and
Hiroyuki Tanaka

Filed : Concurrently herewith

For : SHARED ERROR DETECTION AND
CORRECTION MEMORY

Docket No. P258541.US.01

Disclosure No. 2015-0470.00/US

ASSIGNMENT:

☒ Enclosed for recording

☐ Previously recorded

Date: _____

Reel: _____

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned do hereby:

SELL, ASSIGN AND TRANSFER to **Micron Technology, Inc.** (the "Assignee"), a corporation of Delaware, having a place of business at 8000 South Federal Way, Boise, Idaho 83716-9632, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith and is entitled "**SHARED ERROR DETECTION AND CORRECTION MEMORY**"; such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States of America;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to

others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.

Signature:

Tomoyuki Shibata

Date:

6/15/2016

Assignor Name:

Tomoyuki Shibata

Witness 1:

Signature:

Shoko Tomita

Date:

6/15/2016

Witness Name: Shoko Tomita

Witness 2:

Signature:

Miku Takemasa

Date:

6/15/2016

Witness Name: Miku Takemasa

Signature: Chikara Kondo

Date: 6/15/2016

Assignor Name: Chikara Kondo

Witness 1:

Signature: Shoko Tomita

Date: 6/15/2016

Witness Name: Shoko Tomita

Witness 2:

Signature: Miku Takemasa

Date: 6/15/2016

Witness Name: Miku Takemasa

Signature: Hiroyuki Tanaka

Date: 6/15/2016

Assignor Name: Hiroyuki Tanaka

Witness 1:

Signature: Shoko Tomita

Date: 6/15/2016

Witness Name: Shoko Tomita

Witness 2:

Signature: Miku Takemasa

Date: 6/15/2016

Witness Name: Miku Takemasa